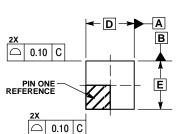
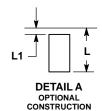
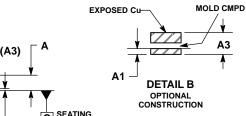


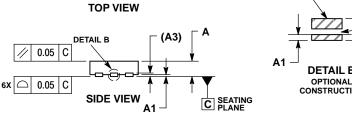
DATE 26 OCT 2007

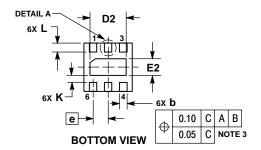


SCALE 4:1

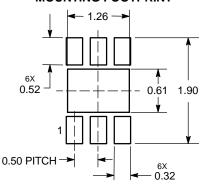








SOLDERMASK DEFINED MOUNTING FOOTPRINT*



DIMENSIONS: MILLIMETERS

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M. 1994.
- ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION b APPLIES TO PLATED TERMINAL
 AND IS MEASURED BETWEEN 0.15 AND
 0.30 NM FROM TERMINAL.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.45	0.55	
A1	0.00	0.05	
A3	0.13 REF		
b	0.20	0.30	
D	1.60 BSC 1.60 BSC		
Е			
е	0.50 BSC		
D2	1.10	1.30	
E2	0.45	0.65	
K	0.20		
L	0.20	0.40	
L1	0.00	0.15	

GENERIC MARKING DIAGRAM*



XX = Specific Device Code

M = Date Code

■ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

DESCRIPTION:	6 PIN UDFN, 1.6X1.6, 0.5P		PAGE 1 OF 2
NEW STANDARD:		"CONTROLLED COPY" in red.	
STATUS:	ON SEMICONDUCTOR STANDARD	accessed directly from the Document versions are uncontrolled except	
DOCUMENT NUMBER:	98AON25711D	Electronic versions are uncontrolle	

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



DOCUMENT	NUMBER:
98AON25711	D

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ISSUE	REVISION	DATE
0	RELEASED FOR PRODUCTION. REQ. BY N. LOPEZ.	26 OCT 2007

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 Semiconductor Components Industries, LLC, 2007 Case Outline Number: October, 2007 - Rev. 010 517AP